

74LV4052

Dual 4-channel analog multiplexer/demultiplexer

Rev. 7 — 29 March 2024

Product data sheet

1. General description

The 74LV4052 is a dual single-pole quad-throw analog switch suitable for use in 4:1 multiplexer/demultiplexer applications. Each switch features four independent inputs/outputs (nY0, nY1, nY2 and nY3) and a common input/output (nZ). A digital enable input (E) and two digital select inputs (S0, S1) are common to both switches. When $\bar{E}$ is HIGH, the switches are turned off. Digital inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess V_{CC} .

2. Features and benefits

- Wide supply voltage range from 1.0 to 6.0 V
- CMOS low power dissipation
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Optimized for low-voltage applications: 1.0 V to 6.0 V
- Accepts TTL input levels between $V_{CC} = 2.7$ V and $V_{CC} = 3.6$ V
- Low ON resistance:
 - 145 Ω (typical) at $V_{CC} - V_{EE} = 2.0$ V
 - 90 Ω (typical) at $V_{CC} - V_{EE} = 3.0$ V
 - 60 Ω (typical) at $V_{CC} - V_{EE} = 4.5$ V
- Logic level translation:
 - To enable 3 V logic to communicate with ± 3 V analog signals
- Typical 'break before make' built in
- Complies with JEDEC standards:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to $+85$ °C and from -40 °C to $+125$ °C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LV4052D	-40 °C to $+125$ °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74LV4052PW	-40 °C to $+125$ °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

4. Functional diagram

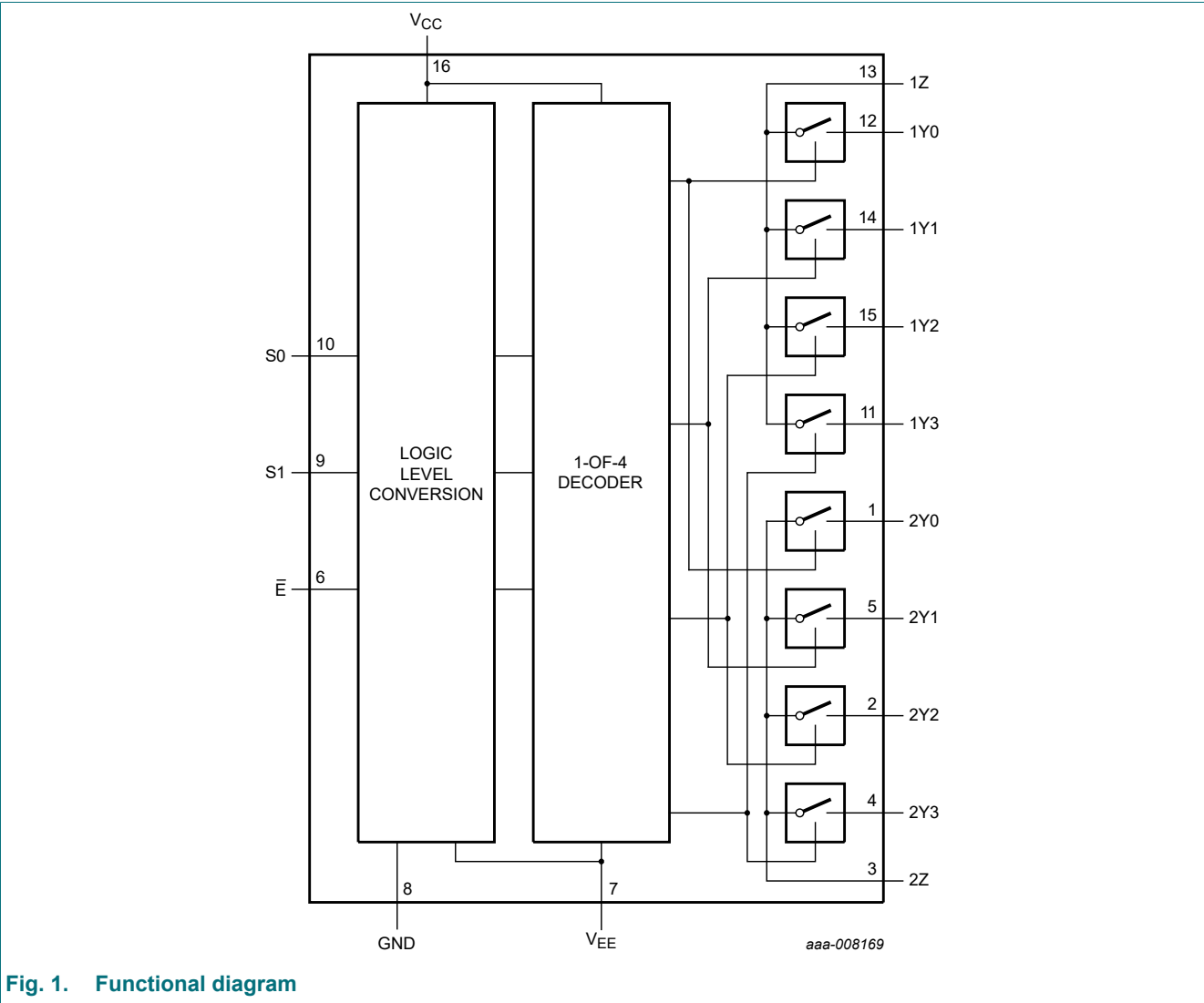


Fig. 1. Functional diagram

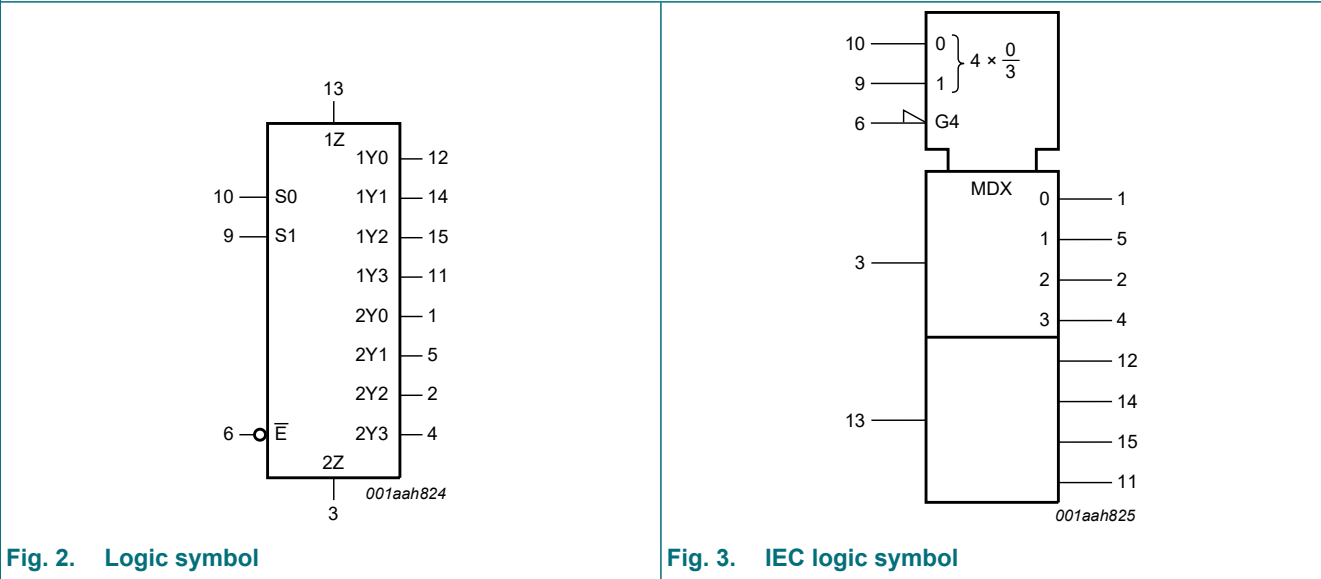


Fig. 2. Logic symbol

Fig. 3. IEC logic symbol

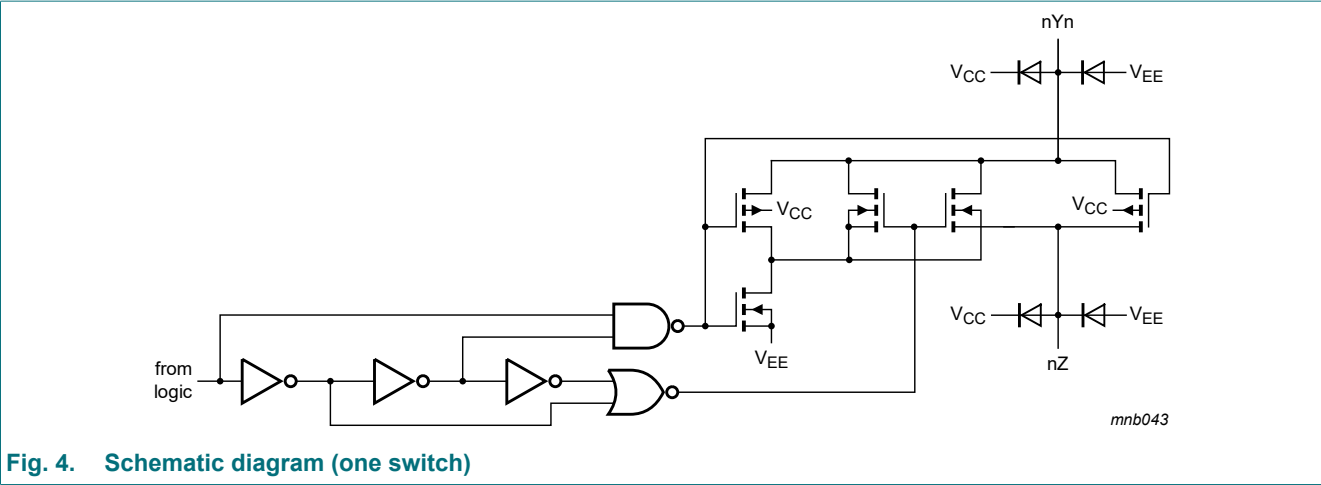
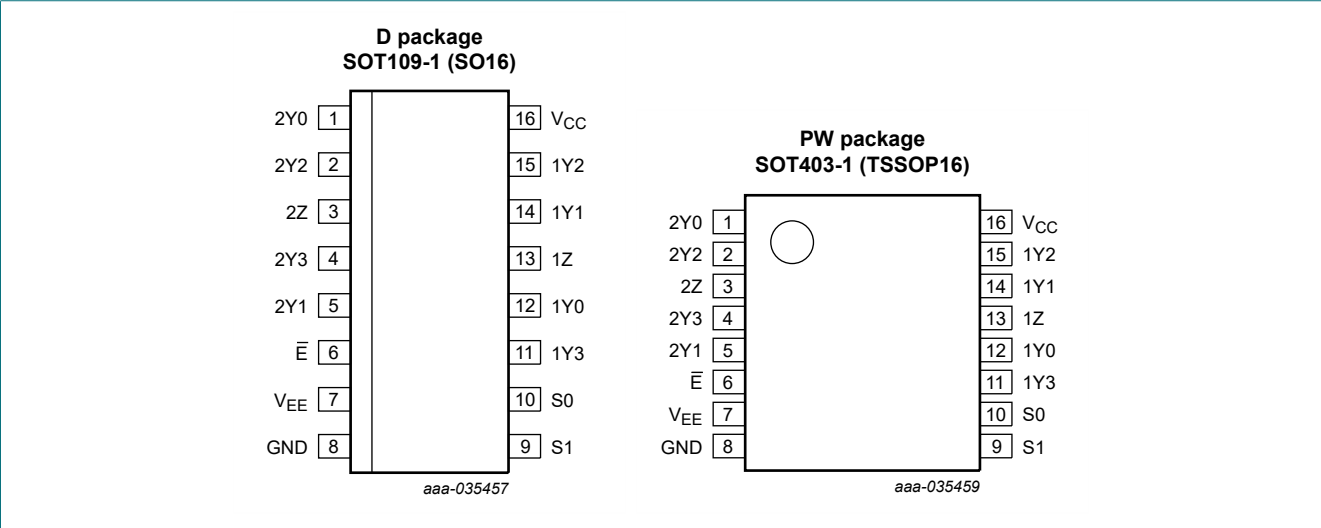


Fig. 4. Schematic diagram (one switch)

5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
2Y0, 2Y1, 2Y2, 2Y3	1, 5, 2, 4	independent input or output
E	6	enable input (active LOW)
V _{EE}	7	negative supply voltage
GND	8	ground (0 V)
S0, S1	10, 9	select logic input
1Y0, 1Y1, 1Y2, 1Y3	12, 14, 15, 11	independent input or output
1Z, 2Z	13, 3	common input or output
V _{CC}	16	positive supply voltage

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care.

Input			Channel on
E	S1	S0	
L	L	L	nY0 and nZ
L	L	H	nY1 and nZ
L	H	L	nY2 and nZ
L	H	H	nY3 and nZ
H	X	X	none

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to $V_{SS} = 0\text{ V}$ (ground).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage	[1]	-0.5	+7.0	V
I_{IK}	input clamping current	$V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$ [2]	-	± 20	mA
I_{SK}	switch clamping current	$V_{SW} < -0.5\text{ V}$ or $V_{SW} > V_{CC} + 0.5\text{ V}$ [2]	-	± 20	mA
I_{SW}	switch current	$V_{SW} > -0.5\text{ V}$ or $V_{SW} < V_{CC} + 0.5\text{ V}$; source or sink current [2]	-	± 25	mA
T_{stg}	storage temperature		-65	+150	°C
P_{tot}	total power dissipation	$T_{amb} = -40\text{ °C}$ to $+125\text{ °C}$ [3]	-	500	mW

- [1] To avoid drawing V_{CC} current out of terminal nZ, when switch current flows into terminals nYn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no V_{CC} current flows out of terminals nYn. In this case, there is no limit for the voltage drop across the switch, but the voltages at nYn and nZ may not exceed V_{CC} or V_{EE} .
- [2] The minimum input voltage rating may be exceeded if the input current rating is observed.
- [3] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.
For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage	see Fig. 5 [1]	1	3.3	6	V
V_I	input voltage		0	-	V_{CC}	V
V_{SW}	switch voltage		0	-	V_{CC}	V
T_{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.0\text{ V}$ to 2.0 V	-	-	500	ns/V
		$V_{CC} = 2.0\text{ V}$ to 2.7 V	-	-	200	ns/V
		$V_{CC} = 2.7\text{ V}$ to 6.0 V	-	-	100	ns/V

- [1] The static characteristics are guaranteed from $V_{CC} = 1.2\text{ V}$ to 6.0 V . However, LV devices are guaranteed to function down to $V_{CC} = 1.0\text{ V}$ (with input levels GND or V_{CC}).

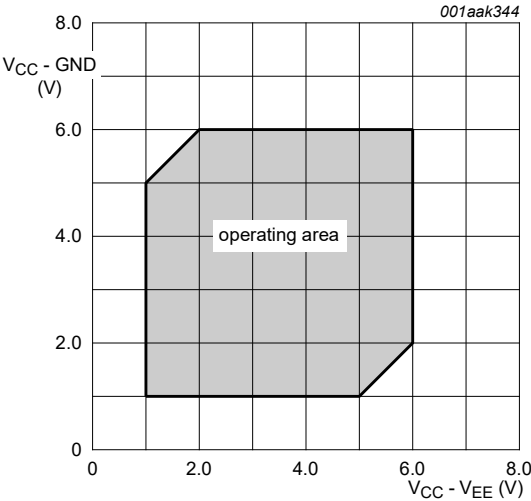


Fig. 5. Guaranteed operating area as a function of the supply voltages

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level input voltage	V _{CC} = 1.2 V	0.9	-	-	0.9	-	V
		V _{CC} = 2.0 V	1.4	-	-	1.4	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
		V _{CC} = 4.5 V	3.15	-	-	3.15	-	V
		V _{CC} = 6.0 V	4.20	-	-	4.20	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 1.2 V	-	-	0.3	-	0.3	V
		V _{CC} = 2.0 V	-	-	0.6	-	0.6	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
		V _{CC} = 4.5 V	-	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	-	1.80	-	1.80	V
I _I	input leakage current	V _I = V _{CC} or GND						
		V _{CC} = 3.6 V	-	-	1.0	-	1.0	μA
		V _{CC} = 6.0 V	-	-	2.0	-	2.0	μA
I _{S(OFF)}	OFF-state leakage current	V _I = V _{IH} or V _{IL} ; see Fig. 6						
		V _{CC} = 3.6 V	-	-	1.0	-	1.0	μA
		V _{CC} = 6.0 V	-	-	2.0	-	2.0	μA
I _{S(ON)}	ON-state leakage current	V _I = V _{IH} or V _{IL} ; see Fig. 7						
		V _{CC} = 3.6 V	-	-	1.0	-	1.0	μA
		V _{CC} = 6.0 V	-	-	2.0	-	2.0	μA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A						
		V _{CC} = 3.6 V	-	-	20	-	40	μA
		V _{CC} = 6.0 V	-	-	40	-	80	μA
ΔI _{CC}	additional supply current	per input; V _I = V _{CC} - 0.6 V; V _{CC} = 2.7 V to 3.6 V	-	-	500	-	850	μA

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Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
C _I	input capacitance		-	3.5	-	-	-	pF
C _{sw}	switch capacitance	independent pins nYn	-	5	-	-	-	pF
		common pins nZ	-	12	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C.

9.1. Test circuits

$V_I = V_{CC}$ or V_{EE} and $V_O = V_{EE}$ or V_{CC} .

Fig. 6. Test circuit for measuring OFF-state leakage current

$V_I = V_{CC}$ or V_{EE} and $V_O = \text{open circuit}$.

Fig. 7. Test circuit for measuring ON-state leakage current

9.2. ON resistance

Table 7. ON resistance
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit and graph see Fig. 8 and Fig. 9.

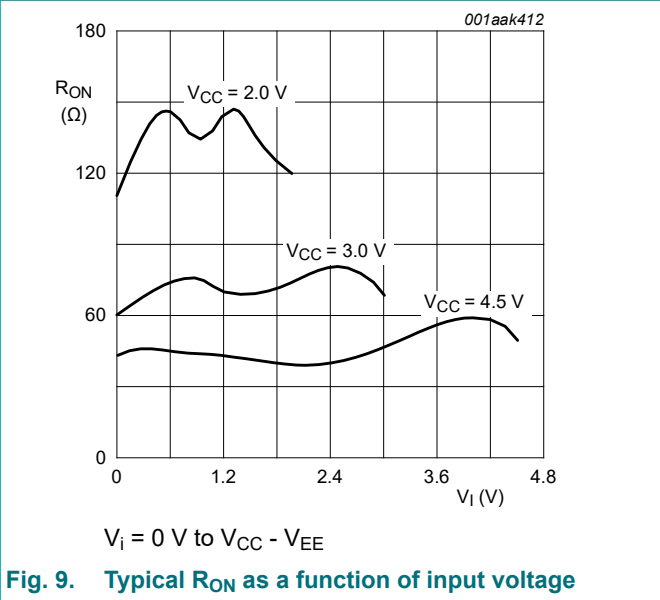
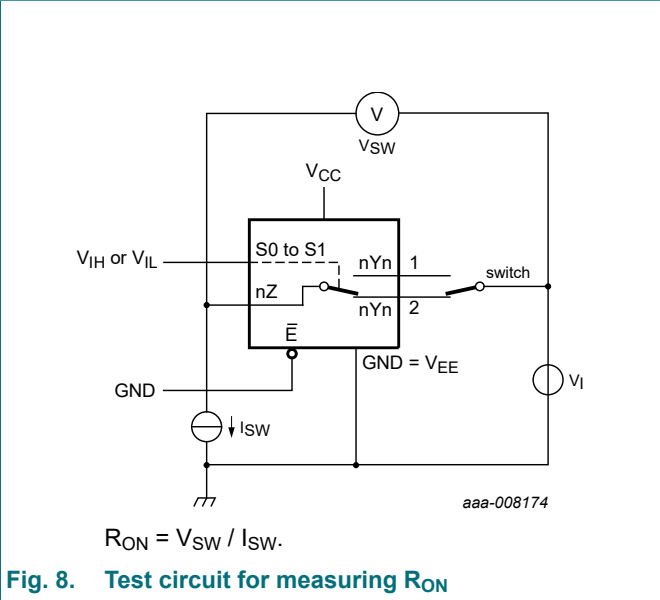
Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
R _{ON(peak)}	ON resistance (peak)	$V_I = 0\text{ V to }V_{CC} - V_{EE}$						
		$V_{CC} = 1.2\text{ V}; I_{SW} = 100\text{ }\mu\text{A}$ [2]	-	-	-	-	-	Ω
		$V_{CC} = 2.0\text{ V}; I_{SW} = 1000\text{ }\mu\text{A}$	-	145	325	-	375	Ω
		$V_{CC} = 2.7\text{ V}; I_{SW} = 1000\text{ }\mu\text{A}$	-	90	200	-	235	Ω
		$V_{CC} = 3.0\text{ V to }3.6\text{ V}; I_{SW} = 1000\text{ }\mu\text{A}$	-	80	180	-	210	Ω
		$V_{CC} = 4.5\text{ V}; I_{SW} = 1000\text{ }\mu\text{A}$	-	60	135	-	160	Ω
		$V_{CC} = 6.0\text{ V}; I_{SW} = 1000\text{ }\mu\text{A}$	-	55	125	-	145	Ω
ΔR_{ON}	ON resistance mismatch between channels	$V_I = 0\text{ V to }V_{CC} - V_{EE}$						
		$V_{CC} = 1.2\text{ V}; I_{SW} = 100\text{ }\mu\text{A}$ [2]	-	-	-	-	-	Ω
		$V_{CC} = 2.0\text{ V}; I_{SW} = 1000\text{ }\mu\text{A}$	-	5	-	-	-	Ω
		$V_{CC} = 2.7\text{ V}; I_{SW} = 1000\text{ }\mu\text{A}$	-	4	-	-	-	Ω
		$V_{CC} = 3.0\text{ V to }3.6\text{ V}; I_{SW} = 1000\text{ }\mu\text{A}$	-	4	-	-	-	Ω
		$V_{CC} = 4.5\text{ V}; I_{SW} = 1000\text{ }\mu\text{A}$	-	3	-	-	-	Ω
		$V_{CC} = 6.0\text{ V}; I_{SW} = 1000\text{ }\mu\text{A}$	-	2	-	-	-	Ω

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
R _{ON(rail)}	ON resistance (rail)	V _I = GND						
		V _{CC} = 1.2 V; I _{SW} = 100 µA [2]	-	225	-	-	-	Ω
		V _{CC} = 2.0 V; I _{SW} = 1000 µA	-	110	235	-	270	Ω
		V _{CC} = 2.7 V; I _{SW} = 1000 µA	-	70	145	-	165	Ω
		V _{CC} = 3.0 V to 3.6 V; I _{SW} = 1000 µA	-	60	130	-	150	Ω
		V _{CC} = 4.5 V; I _{SW} = 1000 µA	-	45	100	-	115	Ω
		V _{CC} = 6.0 V; I _{SW} = 1000 µA	-	40	85	-	100	Ω
R _{ON(rail)}	ON resistance (rail)	V _I = V _{CC} - V _{EE}						
		V _{CC} = 1.2 V; I _{SW} = 100 µA [2]	-	250	-	-	-	Ω
		V _{CC} = 2.0 V; I _{SW} = 1000 µA	-	120	320	-	370	Ω
		V _{CC} = 2.7 V; I _{SW} = 1000 µA	-	75	195	-	225	Ω
		V _{CC} = 3.0 V to 3.6 V; I _{SW} = 1000 µA	-	70	175	-	205	Ω
		V _{CC} = 4.5 V; I _{SW} = 1000 µA	-	50	130	-	150	Ω
		V _{CC} = 6.0 V; I _{SW} = 1000 µA	-	45	120	-	135	Ω

[1] Typical values are measured at T_{amb} = 25 °C.

[2] When supply voltages (V_{CC} - V_{EE}) near 1.2 V the analog switch ON resistance becomes extremely non-linear. When using a supply of 1.2 V, only use these devices for transmitting digital signals.

9.3. On resistance test circuit and graph



10. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit, see Fig. 12.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	nYn to nZ, nZ to nYn; see Fig. 10 [2]						
		V _{CC} = 1.2 V	-	25	-	-	-	ns
		V _{CC} = 2.0 V	-	9	17	-	20	ns
		V _{CC} = 2.7 V	-	6	13	-	15	ns
		V _{CC} = 3.0 V to 3.6 V [3]	-	5	10	-	12	ns
		V _{CC} = 4.5 V	-	4	9	-	10	ns
		V _{CC} = 6.0 V	-	3	7	-	8	ns
t _{en}	enable time	$\bar{E}$, Sn to nYn, nZ; see Fig. 11 [2]						
		V _{CC} = 1.2 V	-	190	-	-	-	ns
		V _{CC} = 2.0 V	-	65	121	-	146	ns
		V _{CC} = 2.7 V	-	48	89	-	108	ns
		V _{CC} = 3.0 V to 3.6 V; C _L = 15 pF [3]	-	30	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V [3]	-	36	71	-	86	ns
		V _{CC} = 4.5 V	-	32	60	-	73	ns
t _{dis}	disable time	$\bar{E}$, Sn to nYn, nZ; see Fig. 11 [2]						
		V _{CC} = 1.2 V	-	125	-	-	-	ns
		V _{CC} = 2.0 V	-	43	80	-	95	ns
		V _{CC} = 2.7 V	-	33	59	-	71	ns
		V _{CC} = 3.0 V to 3.6 V; C _L = 15 pF [3]	-	22	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V [3]	-	26	48	-	57	ns
		V _{CC} = 4.5 V	-	23	41	-	49	ns
C _{PD}	power dissipation capacitance	C _L = 50 pF; f _i = 1 MHz; [4]	-	57	-	-	-	pF
		V _I = GND to V _{CC}						

[1] All typical values are measured at T_{amb} = 25 °C.
[2] t_{pd} is the same as t_{PLH} and t_{PHL}.
t_{en} is the same as t_{PZL} and t_{PZH}.
t_{dis} is the same as t_{PLZ} and t_{PHZ}.
[3] Typical values are measured at nominal supply voltage (V_{CC} = 3.3 V).
[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
P_D = C_{PD} × V_{CC}² × f_i × N + Σ((C_L + C_{sw}) × V_{CC}² × f_o) where:
f_i = input frequency in MHz, f_o = output frequency in MHz
C_L = output load capacitance in pF
C_{sw} = maximum switch capacitance in pF;
V_{CC} = supply voltage in Volts
N = number of inputs switching
Σ(C_L × V_{CC}² × f_o) = sum of the outputs.

10.1. Waveforms and test circuit

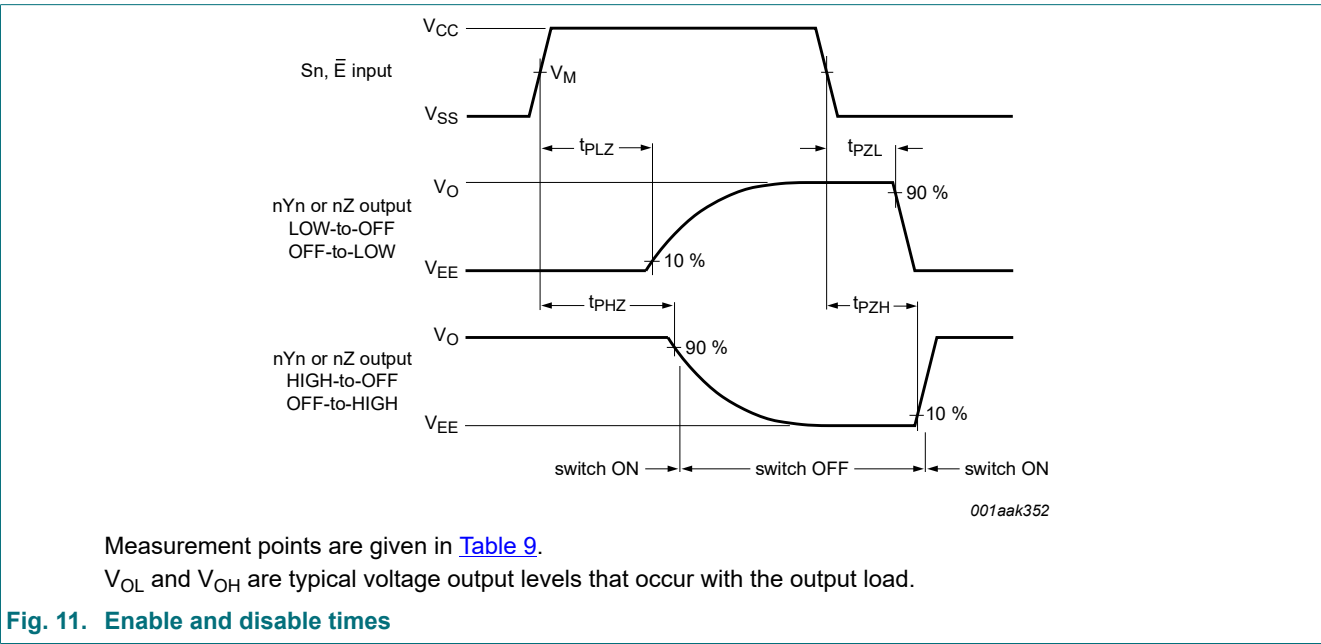
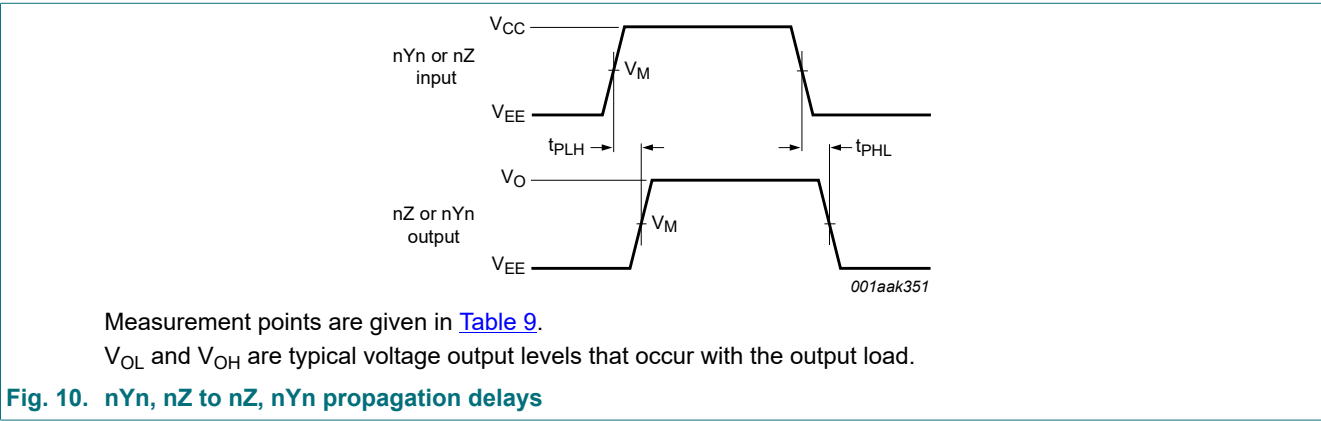


Table 9. Measurement points

Supply voltage	Input	Output
V_{CC}	V_M	V_M
< 2.7 V	$0.5V_{CC}$	$0.5V_{CC}$
2.7 V to 3.6 V	1.5 V	1.5 V
> 3.6 V	$0.5V_{CC}$	$0.5V_{CC}$

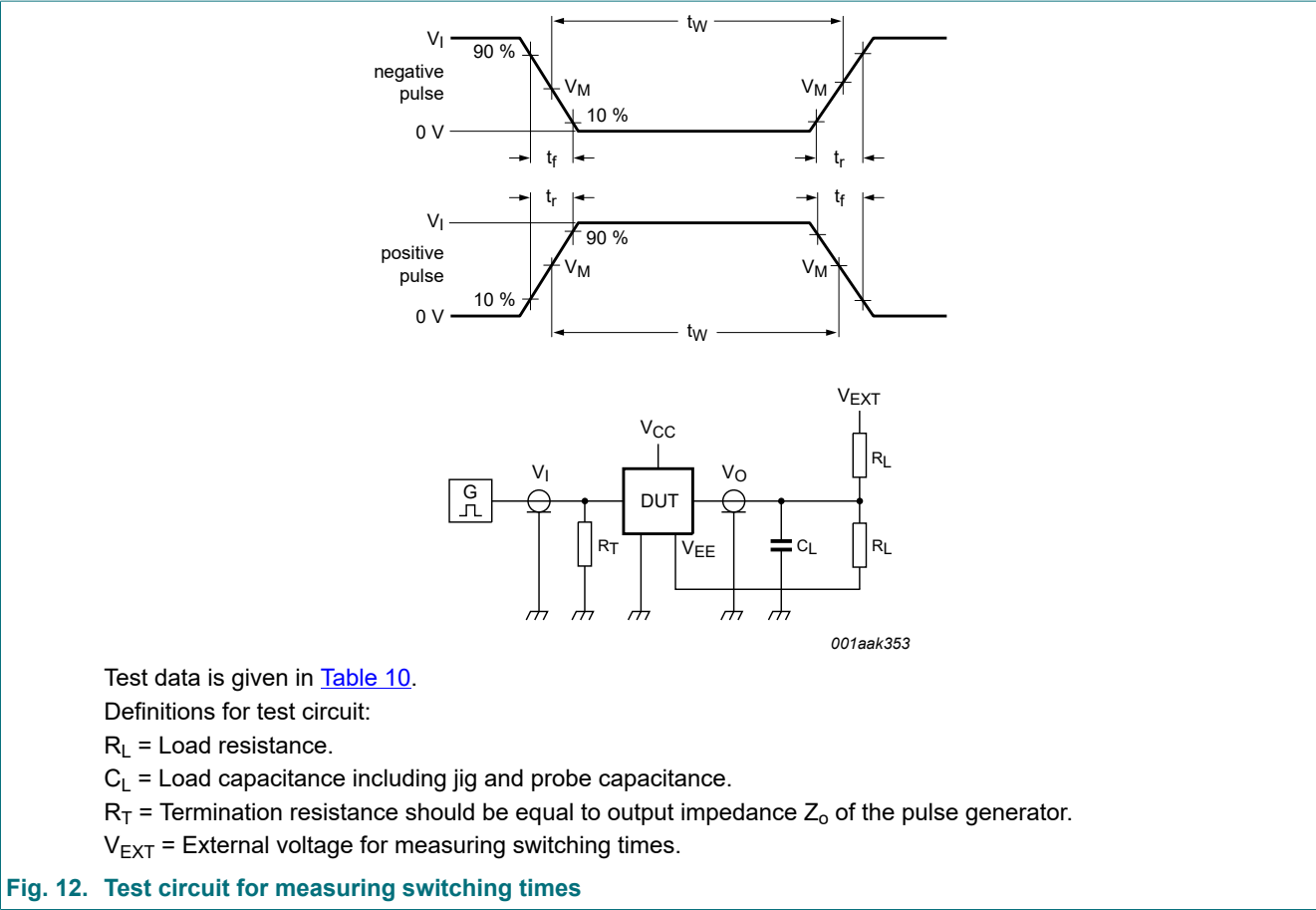


Table 10. Test data

Supply voltage	Input		Load		V_{EXT}		
V_{CC}	V_I	t_r, t_f	C_L	R_L	t_{PHL}, t_{PLH}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
< 2.7 V	V_{CC}	≤ 6 ns	50 pF	1 k Ω	open	V_{EE}	$2V_{CC}$
2.7 V to 3.6 V	2.7 V	≤ 6 ns	15 pF, 50 pF	1 k Ω	open	V_{EE}	$2V_{CC}$
> 3.6 V	V_{CC}	≤ 6 ns	50 pF	1 k Ω	open	V_{EE}	$2V_{CC}$

10.2. Additional dynamic parameters

Table 11. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \leq 6.0$ ns; $T_{amb} = 25$ °C.

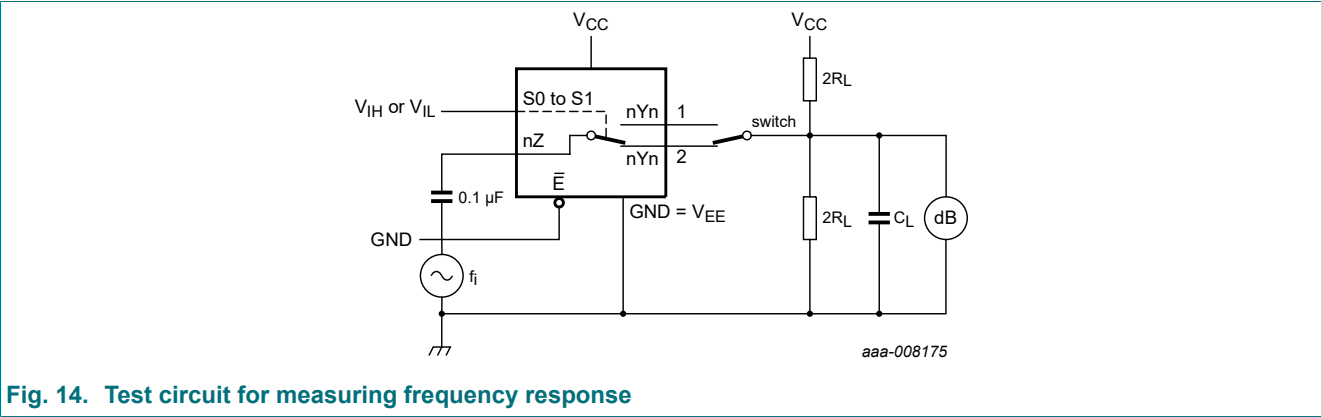
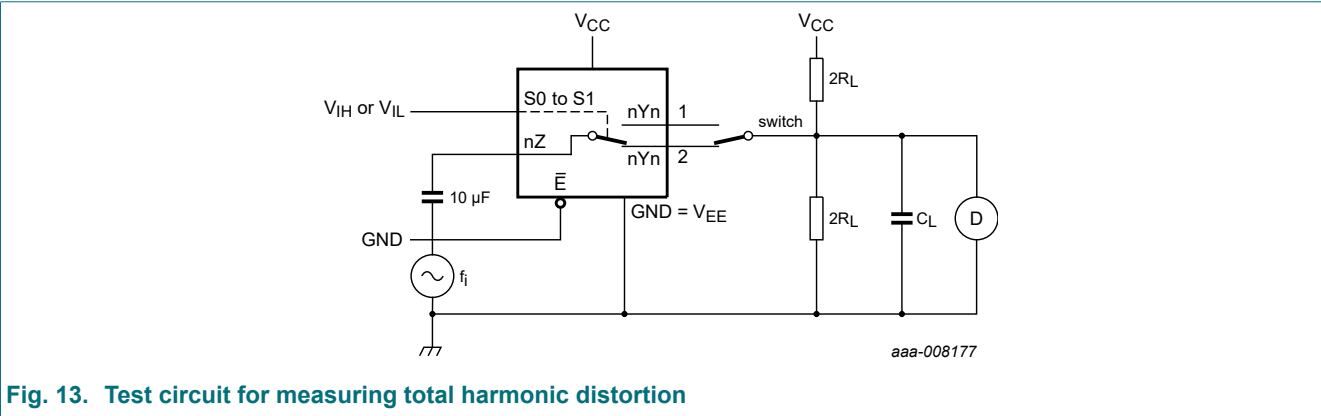
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
THD	total harmonic distortion	$f_i = 1$ kHz; $C_L = 50$ pF; $R_L = 10$ k Ω ; see Fig. 13				
		$V_{CC} = 3.0$ V; $V_I = 2.75$ V (p-p)	-	0.8	-	%
		$V_{CC} = 6.0$ V; $V_I = 5.5$ V (p-p)	-	0.4	-	%
		$f_i = 10$ kHz; $C_L = 50$ pF; $R_L = 10$ k Ω ; see Fig. 13				
		$V_{CC} = 3.0$ V; $V_I = 2.75$ V (p-p)	-	2.4	-	%
		$V_{CC} = 6.0$ V; $V_I = 5.5$ V (p-p)	-	1.2	-	%
$f_{(-3dB)}$	-3 dB frequency response	$C_L = 50$ pF; $R_L = 50$ Ω ; see Fig. 14 and Fig. 15 [1]				
		$V_{CC} = 3.0$ V	-	180	-	MHz
		$V_{CC} = 6.0$ V	-	200	-	MHz

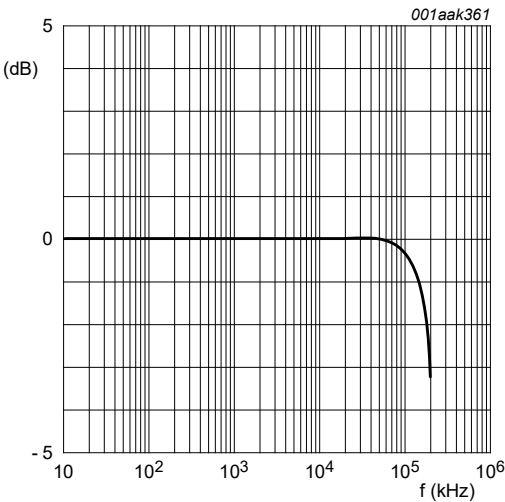
Dual 4-channel analog multiplexer/demultiplexer

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
α_{iso}	isolation (OFF-state)	$f_i = 1\text{ MHz}$; $C_L = 50\text{ pF}$; $R_L = 600\text{ }\Omega$; see Fig. 16 and Fig. 17				
		$V_{CC} = 3.0\text{ V}$	-	-50	-	dB
		$V_{CC} = 6.0\text{ V}$	-	-50	-	dB
V_{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1\text{ MHz}$; $C_L = 50\text{ pF}$; $R_L = 600\text{ }\Omega$; see Fig. 18				
		$V_{CC} = 3.0\text{ V}$	-	0.11	-	V
		$V_{CC} = 6.0\text{ V}$	-	0.12	-	V
Xtalk	crosstalk	between switches; $f_i = 1\text{ MHz}$; $C_L = 50\text{ pF}$; $R_L = 600\text{ }\Omega$; [2] see Fig. 19				
		$V_{CC} = 3.0\text{ V}$	-	-60	-	dB
		$V_{CC} = 6.0\text{ V}$	-	-60	-	dB

- [1] To obtain 0 dBm level at output for 1 MHz (0 dBm = 1 mW into 50 Ω), adjust f_i voltage.
[2] To obtain 0 dBm level at output for 1 MHz (0 dBm = 1 mW into 600 Ω), adjust f_i voltage.

10.2.1. Test circuits





$V_{CC} = 3.0\text{ V}$; $GND = 0\text{ V}$; $V_{EE} = -3.0\text{ V}$; $R_L = 50\text{ }\Omega$; $R_{SOURCE} = 1\text{ k}\Omega$.

Fig. 15. Typical frequency response

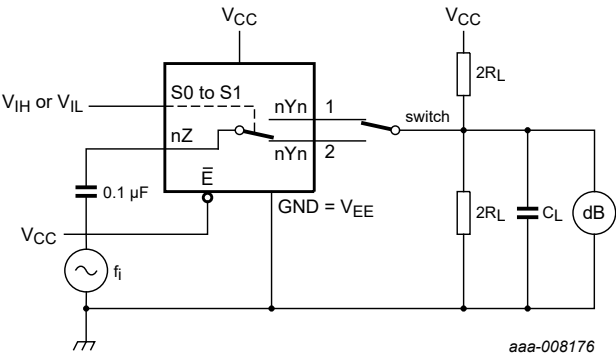
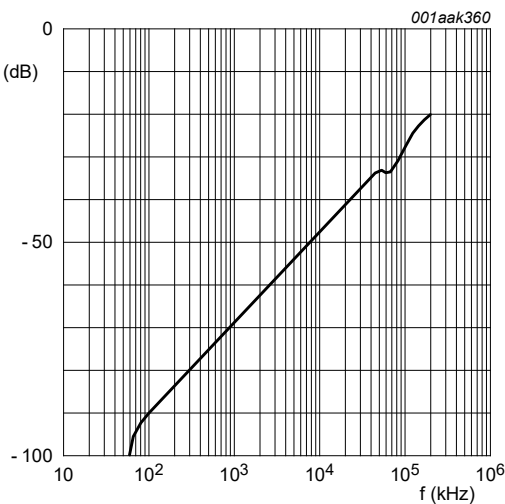
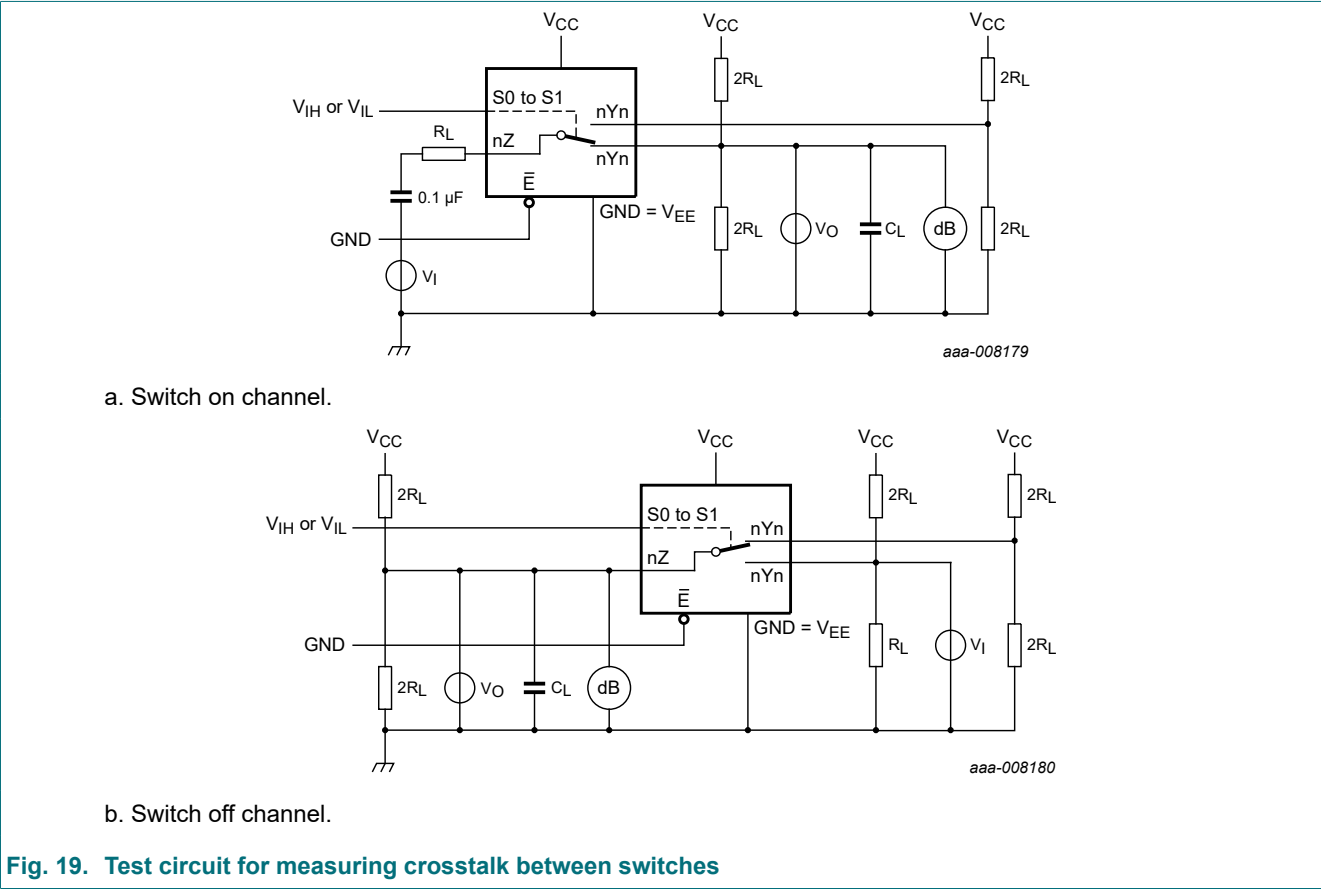
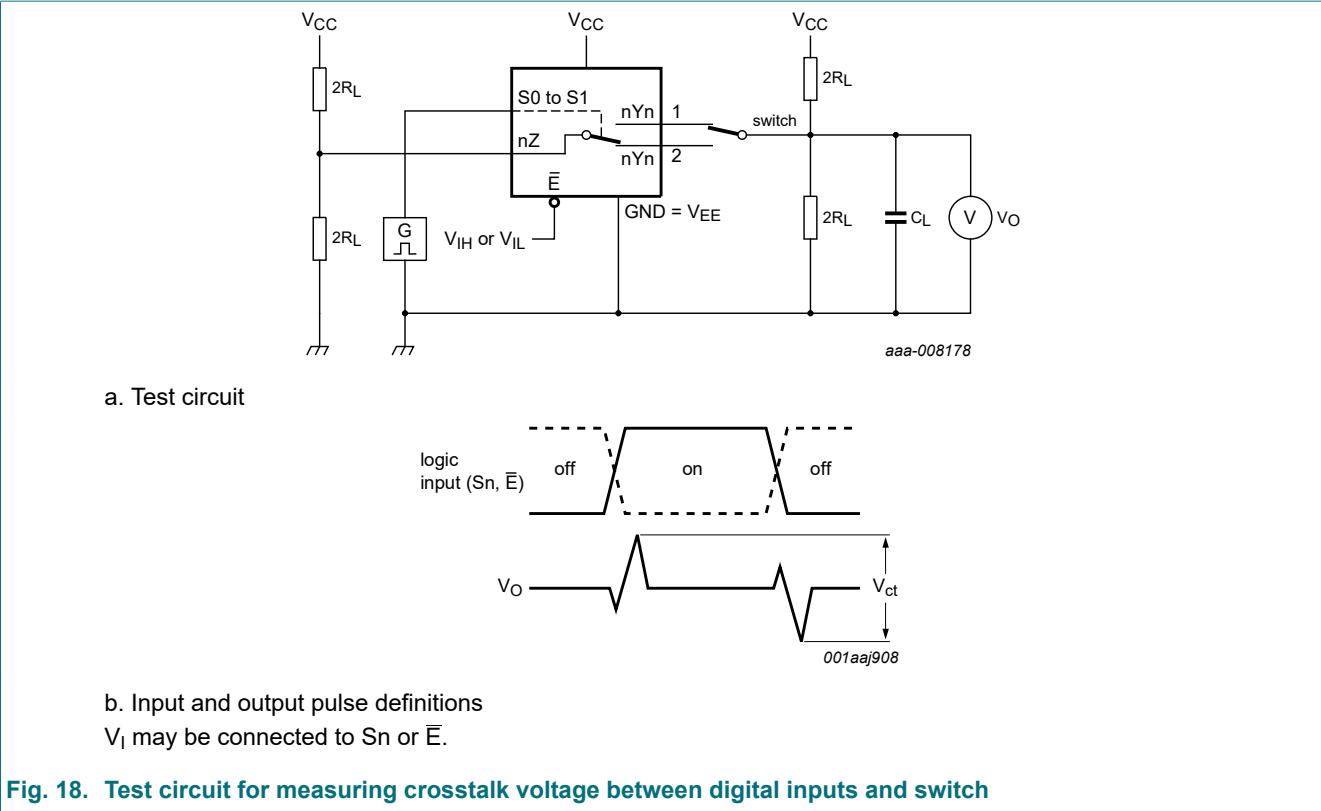


Fig. 16. Test circuit for measuring isolation (OFF-state)



$V_{CC} = 3.0\text{ V}$; $GND = 0\text{ V}$; $V_{EE} = -3.0\text{ V}$; $R_L = 50\text{ }\Omega$; $R_{SOURCE} = 1\text{ k}\Omega$.

Fig. 17. Typical isolation (OFF-state) as function of frequency



11. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

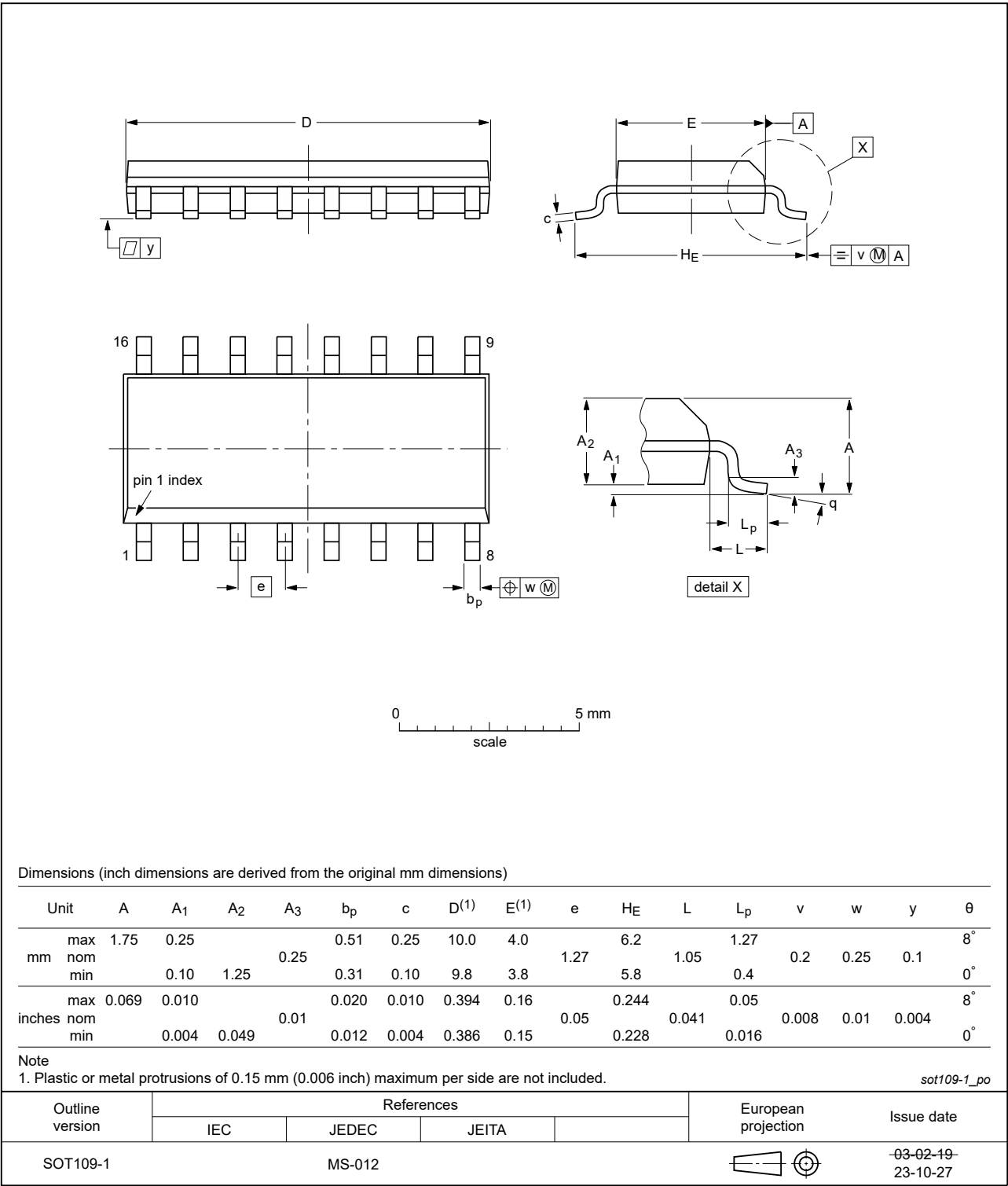


Fig. 20. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

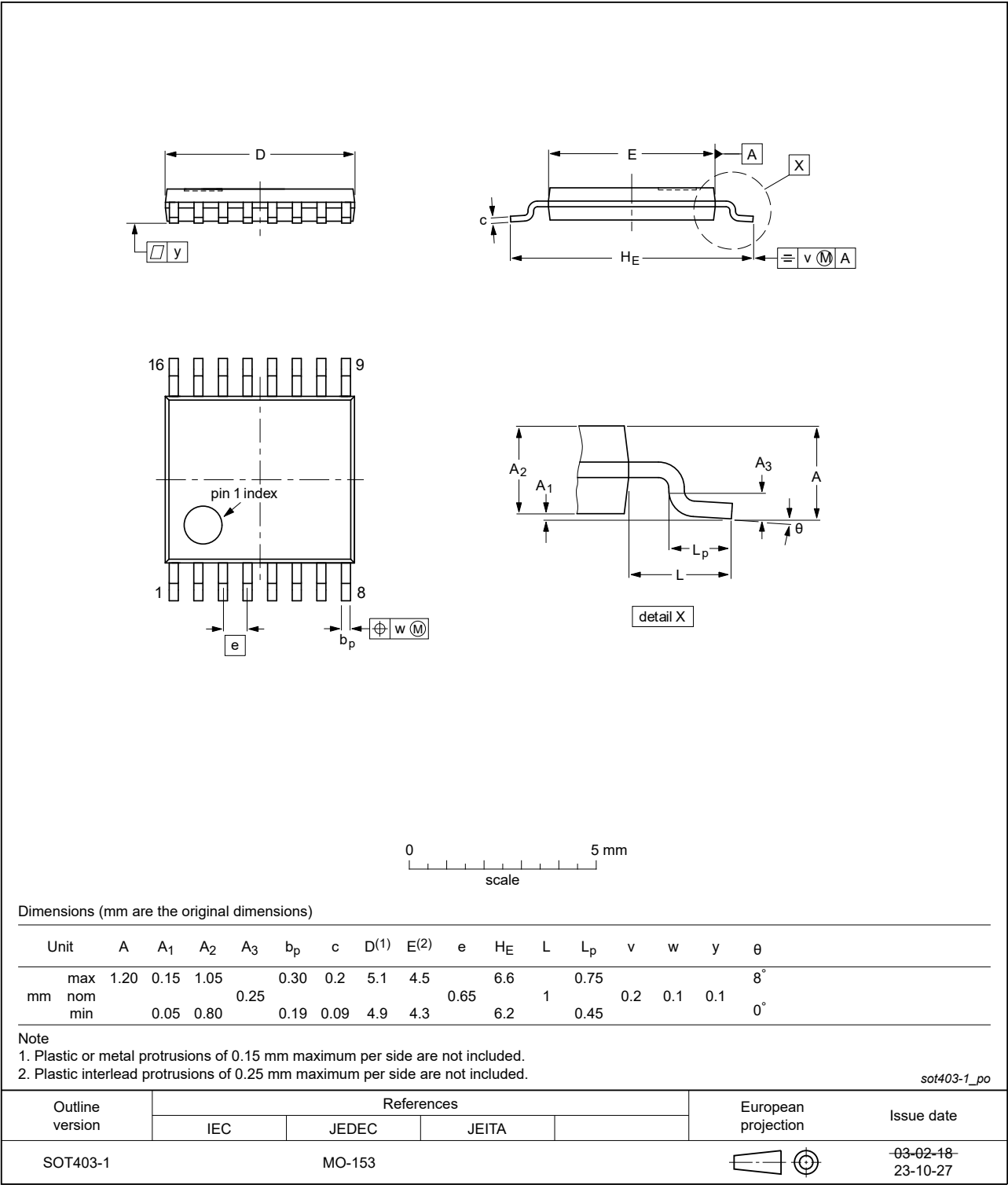


Fig. 21. Package outline SOT403-1 (TSSOP16)

12. Abbreviations

Table 12. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LV4052 v.7	20240329	Product data sheet	-	74LV4052 v.6
Modifications:	• Section 2: ESD specification updated according to the latest JEDEC standard. • Fig. 20 and Fig. 21: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153.			
74LV4052 v.6	20210924	Product data sheet	-	74LV4052 v.5
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • Section 1 and Section 2 updated. • Section 7: Derating values for P_{tot} total power dissipation updated. • Type number 74LV4052DB (SOT338-1/SSOP16) removed.			
74LV4052 v.5	20160317	Product data sheet	-	74LV4052 v.4
Modifications:	• Type number 74LV4052N (SOT38-4) removed.			
74LV4052 v.4	20130701	Product data sheet	-	74LV4052 v.3
Modifications:	• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate.			
74LV4052 v.3	19980623	Product specification	-	74LV4052 v.2
74LV4052 v.2	19970715	Product specification	-	-

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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